

PERSONAL PROFILE

Dr. Andy Hayes worked in conjunction with American Orthodontics to develop PowerScope. Dr. Hayes received his B.S., D.D.S. and M.S.D. degrees from Indiana University. A second generation orthodontist, he treats all types of orthodontic cases with specific interests in growth modification for adolescents, skeletal anchorage in complex cases, and non-visible treatment options. Dr. Hayes is a Clinical Instructor in the St. Louis University Department of Orthodontics and has presented lectures nationally on Class II correction. He serves on the Editorial Advisory Board of Orthotown Magazine and maintains an active private practice limited to orthodontics in St. Louis, Missouri.



EDUCATION

- Indiana University - May 2000
 - B.S. Biology
- Indiana University School of Dentistry - May 2004
 - Doctor of Dental Surgery
- Indiana University School of Dentistry - July 2006
 - M.S. Oral Biology
 - Certificate in Orthodontics

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RESEARCH

- Fractal Analysis to Detect Surface Roughness Changes After Fatigue Loading in the Canine Mandibular Incisor - A Pilot Study 2006, Masters Thesis (M.S.D.)

POSITIONS HELD

- Private Practice: 2006 - present
- Orthotown Magazine - Editorial Advisory Board: June 2011 - present

SIGNIFICANT LECTURES PRESENTED

- December 10, 2010- Pre-restorative Orthodontic Treatment; Update in Dentistry, Greater St. Louis Dental Society- St Louis, MO
- May 15 & 16, 2011- Simplified and Efficient Class II Correction; The American Association of Orthodontists annual meeting- Chicago, IL
- November 4 & 5, 2011- Simplified and Efficient Class II Correction; Tad User's Forum - Las Vegas, NV
- Filmed November 2013 (to be released spring 2014) Online/On Demand CE Orthotown and Dentaltown websites- Pre-Implant Orthodontics; Orthodontically Altering Bone for Implant Site Development

ORTHODONTIC PATENTS

- 2012 "IMPROVED ORTHODONTIC APPLIANCE AND SYSTEM" (US 13/713,963) (PCT WO2013096090 A1)
- 2013 "TELESCOPIC ORTHODONTIC APPLIANCE" (US 13/923,036)